

Thyristors type T75 are of modern design with pressure contacts, high alumina ceramic insulator and cold-welding encapsulation. Designed for use in power electronic circuits and equipment under normal operating conditions.

## KEY PARAMETERS

|                    |                                 |
|--------------------|---------------------------------|
| $U_{DRM}, U_{RRM}$ | <b>up to 2000 V</b>             |
| $I_{T(AV)}$        | <b>650 A</b>                    |
| $I_{TSM}$          | <b>8100 A</b>                   |
| $du/dt^*$          | <b>1000 V/<math>\mu</math>s</b> |
| $di/dt$            | <b>150 A/<math>\mu</math>s</b>  |

\* maximum (non standard) value

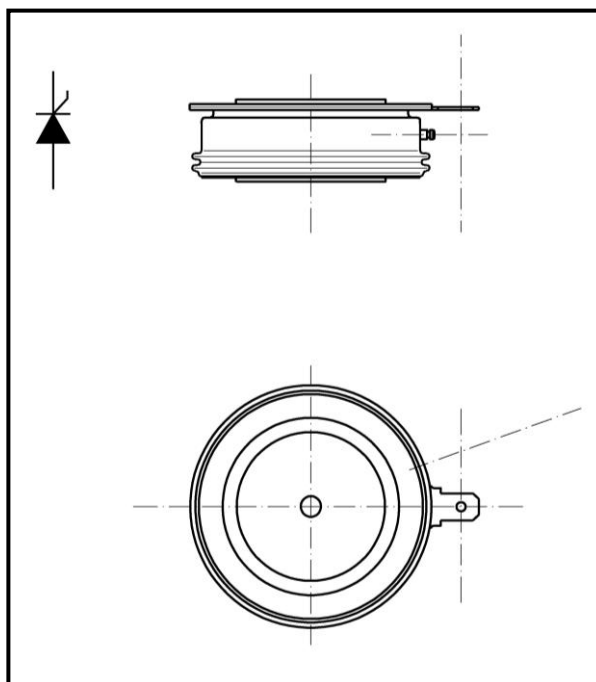
## FEATURES

- all diffused design
- high current capabilities
- high surge current capabilities
- high rates voltages
- high  $du/dt$
- low gate current
- dynamic gate
- low thermal impedance
- tested according to IEC standards
- compact size and small weight

## APPLICATION

- High Power Drives
- DC Motor Control
- High Voltage Power Supplies

Designed for use in high power industrial and commercial electronic circuits and equipment where high currents are encountered and high reliability is essential.



**Outline type code: JEDEC TO-200AB  
(E-puk)**

See package details for further information

# T75-650

## Phase Control Thyristor



KKT75650, March 2003 version

### ORDERING INFORMATION

When ordering please refer to device code builder presented below.  
Please use the complete part number when ordering, quote or in any future correspondence relating to your order.

**T75-650-□□**

└─── voltage class (hundreds of volts)

This is standard device, with no dynamic parameters specified and standard accessory set.  
Please refer to **Electrical Parameters** if specific dynamic demands have to be met.  
Those information, as well as any other concerning non-standard accessories e.g. custom leads length or lead terminal connector type should be included in the order.

### ELECTRICAL PARAMETERS

#### Voltage ratings

| Voltage class | $U_{DRM}, U_{RRM}$ | $U_{DSM}, U_{RSM}$ | $I_{DRM}, I_{RRM}$ |
|---------------|--------------------|--------------------|--------------------|
|               | V                  | V                  | mA                 |
| 04            | 400                | 500                | 30                 |
| 06            | 600                | 700                |                    |
| 08            | 800                | 900                |                    |
| 10            | 1000               | 1100               |                    |
| 12            | 1200               | 1300               |                    |
| 14            | 1400               | 1500               |                    |
| 16            | 1600               | 1700               |                    |
| 18            | 1800               | 1900               |                    |
| 20            | 2000               | 2100               |                    |

#### du/dt group codes

| Group code | du/dt              |
|------------|--------------------|
|            | V/ $\mu$ s         |
| 0          | no specified value |
| 5          | 320                |
| 6          | 500                |
| 7          | 1000               |

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# T75-650

## Phase Control Thyristor



Zakłady Elektronowe  
**LAMINA S.A.**

KKT75650, March 2003 version

### Electrical properties

| Parameter                                   |              | Unit                   | Test conditions   | Value      |
|---|--------------|------------------------|---|------------|
| Average on-state current                    | $I_{T(AV)}$  | A                      |   | 650        |
| Case temperature                            | $T_c$        | °C                     |   | 65         |
| RMS on-state current                        | $I_{T(RMS)}$ | A                      |   | 1000       |
| Surge on-state current                      | $I_{TSM}$    | A                      | $T_j=125^\circ\text{C}$ , $U_R=0,8U_{RRM}$ ,<br>$t_p=10\text{ms}$   | 8100       |
| $I^2t$ – value                              | $I^2t$       | $\text{kA}^2\text{s}$  |   | 330        |
| On-state voltage max.                       | $U_{TM}$     | V                      | $T_j=25^\circ\text{C}$ , $I_{TM}=1500\text{A}$  | 2,0        |
| Threshold voltage                           | $U_{T(T0)}$  | V                      |   | 0,93       |
| Slope resistance                            | $r_T$        | $\text{m}\Omega$       |   | 0,71       |
| Latching current                            | $I_l$        | mA                     | $T_j=25^\circ\text{C}$ , $U_D=12\text{V}$   | 800        |
| Holding current                             | $I_H$        | mA                     | $T_j=25^\circ\text{C}$ , $U_D=12\text{V}$   | 200        |
| Circuit commutated turn-off time (typical)  | $t_q$ (typ)  | $\mu\text{s}$          | $T_j=125^\circ\text{C}$ , $I_{TM}=250\text{A}$ ,<br>$di_R/dt=25\text{A}/\mu\text{s}$ , $du/dt=20\text{V}/\mu\text{s}$ ,<br>$U_D=0,67U_{DRM}$ , $U_{RM}=100\text{V}$ | 150        |
| Turn-On time (typical)                      | $t_{on}$     | $\mu\text{s}$          | $I_{TM}=100\text{A}$ , $U_{DM}=100\text{V}$   | 7          |
| Rate of rise of on-state current-repetitive | $di/dt$      | $\text{A}/\mu\text{s}$ | $T_j=125^\circ\text{C}$ , $I_{TM}=3I_{T(AV)}$ ,<br>$U_D=0,67U_{DRM}$ , $f=50\text{Hz}$ , $I_{GM}=1\text{A}$ ,<br>$di_G/dt=1\text{A}/\mu\text{s}$                    | 150        |
| Critical rate of raise of off-state voltage | $du/dt$      | $\text{V}/\mu\text{s}$ | $T_j=125^\circ\text{C}$ , $U_D=0,67U_{DRM}$ ,   | 320 - 1000 |
| Gate current to trigger                     | $I_{GT}$     | mA                     | $T_j=25^\circ\text{C}$ , $U_D=12\text{V}$   | 150        |
| Gate voltage to trigger                     | $U_{GT}$     | V                      | $T_j=25^\circ\text{C}$ , $U_D=12\text{V}$   | 3          |

### Thermal properties

| Parameter                            |                           | Unit | Test conditions | Value      |
|--------------------------------------|---------------------------|------|-----------------|------------|
| Thermal resistance, junction to case | $R_{thJC}$                | °C/W | two sided, DC   | 0,04       |
| Thermal resistance, case to heatsink | $R_{thCS}$                | °C/W | two sided       | 0,020      |
| Operating junction temperature       | $T_{jmin} \dots T_{jmax}$ | °C   |                 | -40...+125 |
| Storage temperature                  | $T_{stg}$                 | °C   |                 | -40...+125 |

### Mechanical properties

| Parameter      |       | Unit | Value        |
|----------------|-------|------|--------------|
| Clamping force | $F_M$ | kN   | 9,0 ... 11,0 |
| Weight         | m     | g    | 85           |

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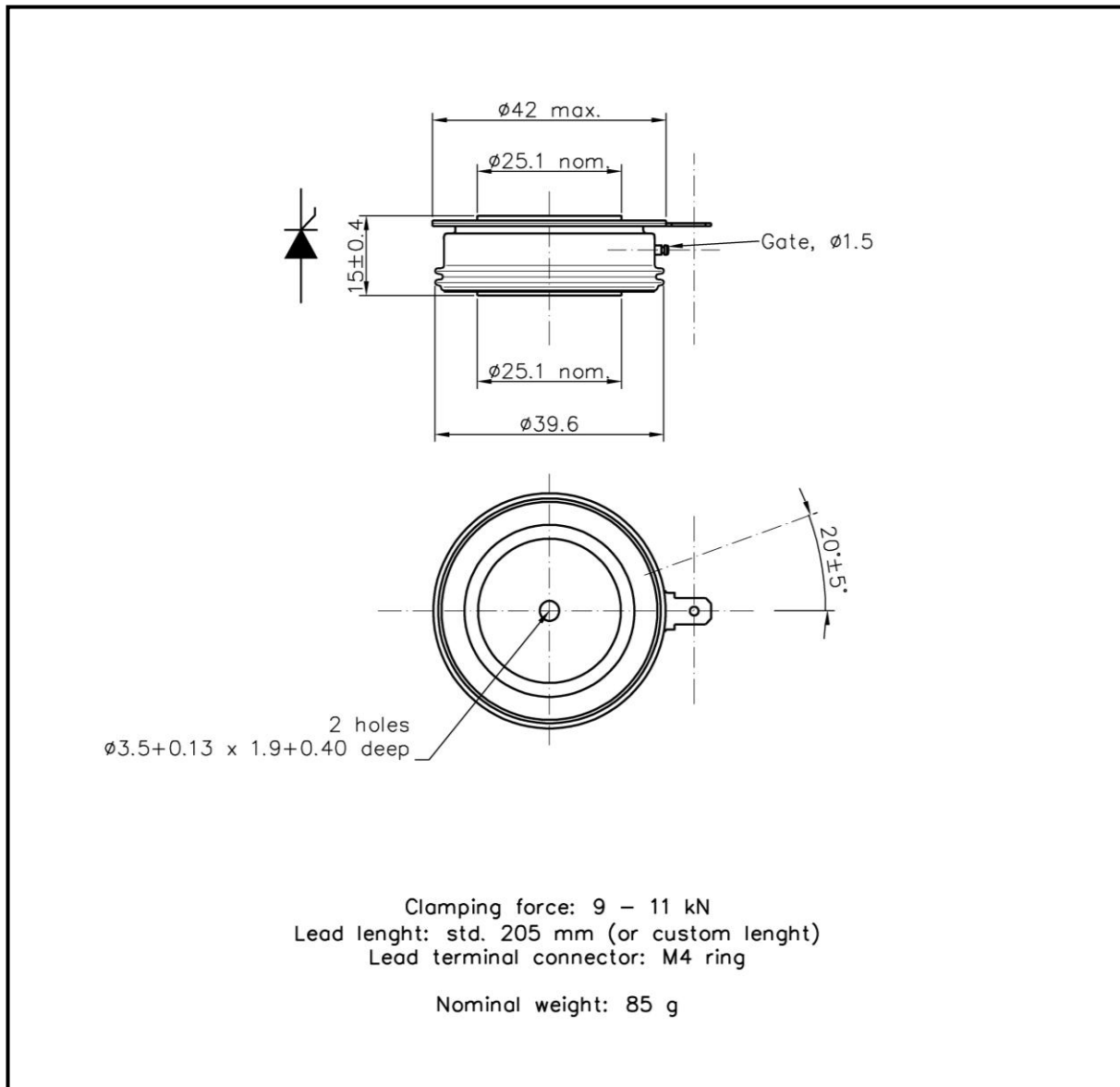
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# T75-650

## Phase Control Thyristor

KKT75650, March 2003 version

### Package details



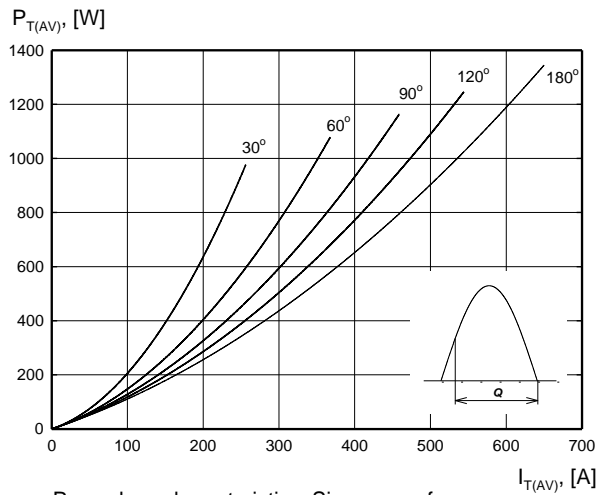
For further package information, please contact Sales & Marketing Department. All dimensions in mm, unless stated otherwise.  
Do not scale.

# T75-650

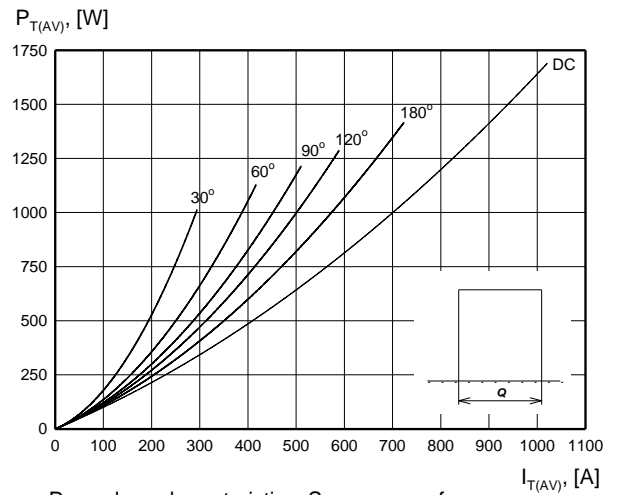
## Phase Control Thyristor

KKT75650, March 2003 version

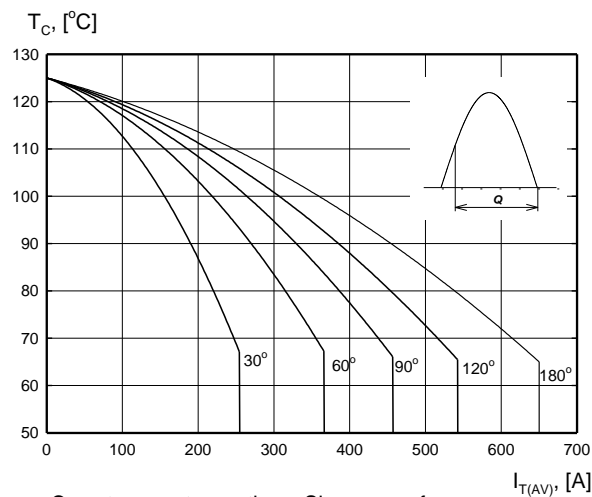
### CHARACTERISTICS



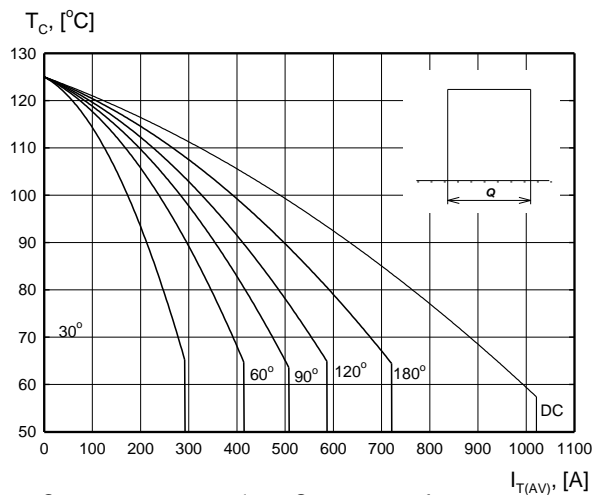
Power loss characteristics. Sinus wave form.



Power loss characteristics. Square wave form.



Case temperature ratings. Sinus wave form.

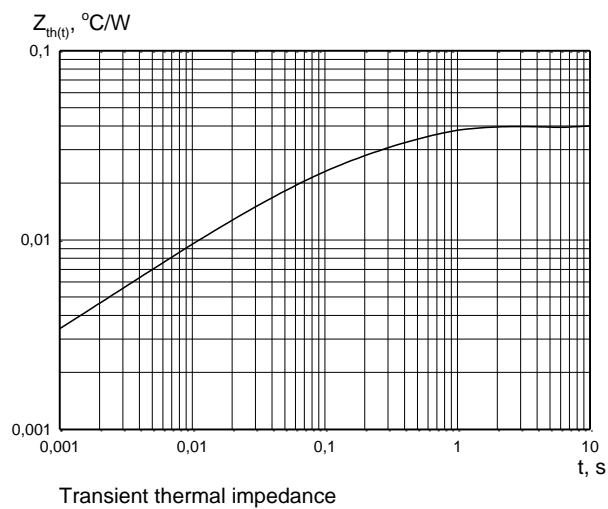
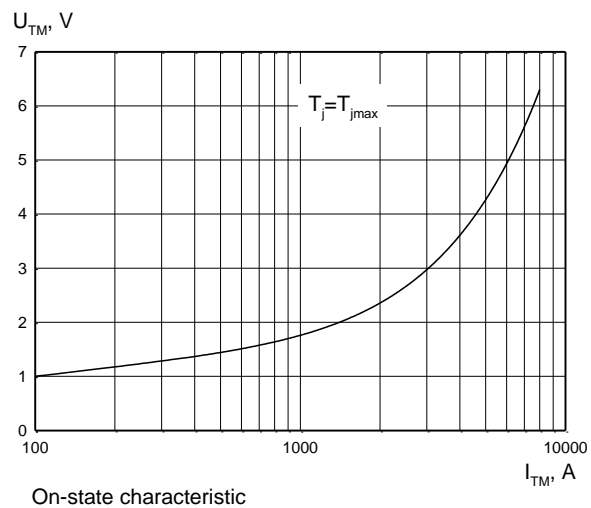
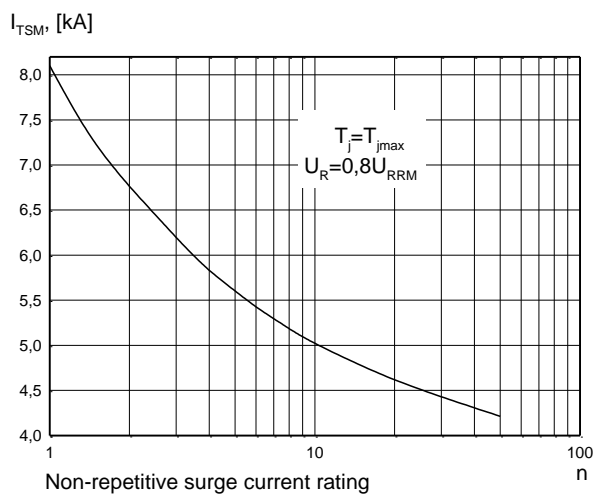


Case temperature ratings. Square wave form.

# T75-650

## Phase Control Thyristor

KKT75650, March 2003 version

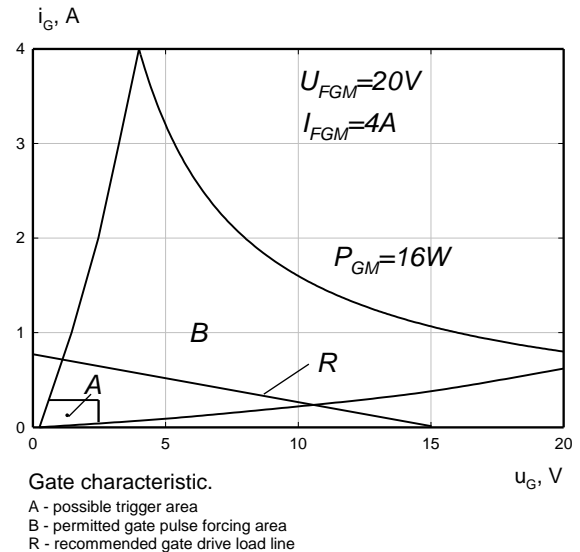
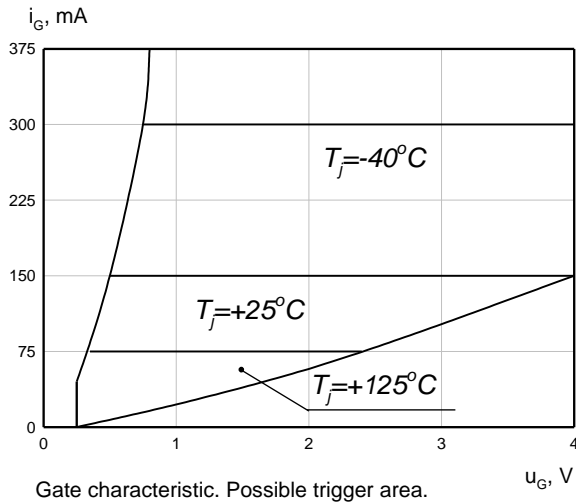


# T75-650

## Phase Control Thyristor

KKT75650, March 2003 version

### Gate characteristics



### HEATSINKS

LAMINA S.I. has its own proprietary range of extruded aluminium heatsinks designed to optimise the performance of our semiconductors with natural and forced air flow. High efficiency water cooled copper heatsinks are also available.

### DEVICE CLAMPS

Disc devices require the correct clamping force to ensure their best operation. LAMINA S.I. offers a wide selection of clamps to suit all of our manufactured devices.

### POWER ASSEMBLY CAPABILITY

LAMINA S.I. provides a support for those customers requiring more than a basic semiconductor and offers precisely assembled Power Blocks according to factory or customer standards.

## X-ON Electronics

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